ECOSPARK[®] Ignition IGBT

300 mJ, 400 V, N-Channel Ignition IGBT

Features

- SCIS Energy = 300 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- This Device is Pb-Free and is RoHS Compliant
- AEC-Q101 Qualified and PPAP Capable

Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Applications

MAXIMUM RATINGS (T_J = 25° C Unless Otherwise Stated)

Parameter	Symbol	Value	Units	
Collector to Emitter Breakdown Voltage $(I_C = 1 \text{ mA})$	BV _{CER}	400	V	
Emitter to Collector Voltage – Reverse Battery Condition (I _C = 10 mA)	BV _{ECS}	24	V	
ISCIS = 14.2 A, L = 3.0 mHz, R _{GE} = 1 K Ω (Note 1), T _C = 25°C	E _{SCIS25}	300	mJ	
ISCIS = 10.6 A, L = 3.0 mHz, R _{GE} = 1 KΩ (Note 2), T _C = 150°C	E _{SCIS150}	170	mJ	
Collector Current Continuous, at V_{GE} = 4.0 V, T_{C} = 25°C	IC25	21	A	
Collector Current Continuous, at V_{GE} = 4.0 V, T_{C} = 110°C	IC110	17	A	
Gate to Emitter Voltage Continuous	V _{GEM}	±10	V	
Power Dissipation Total, $T_C = 25^{\circ}C$	PD	150	W	
Power Dissipation Derating, $T_{C} > 25^{\circ}C$	PD	1	W/°C	
Operating Junction and Storage Temperature	T _J , T _{STG}	–55 to 175	°C	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	ΤL	300	°C	
Reflow soldering according to JESD020C	T _{PKG}	260	°C	
HBM-Electrostatic Discharge Voltage at100 pF, 1500 Ω	ESD	4	kV	
CDM-Electrostatic Discharge Voltage at 1 Ω	ESD	2	kV	
	_			

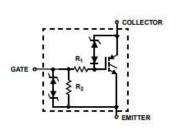
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Self Clamped inductive Switching Energy (ESCIS25) of 300 mJ is based on the test conditions that is starting $T_J = 25^{\circ}$ C, L = 3 mHz, ISCIS = 14.2 A, $V_{CC} = 100$ V during inductor charging and $V_{CC} = 0$ V during time in clamp.
- 2. Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting $T_J = 150^{\circ}$ C, L = 3 mHz, ISCIS = 10.6 A, $V_{CC} = 100$ V during inductor charging and $V_{CC} = 0$ V during time in clamp.



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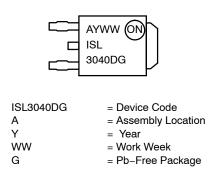
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DPAK (SINGLE GAUGE) CASE 369C

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Characteristic	Symbol	Max	Units	
Junction-to-Case - Steady State (Drain) (Notes 1, 3 and 4)	$R_{\theta JC}$	1	°C/W	

ELECTRICAL CHARACTERISTICS (T_J = 25° C Unless Otherwise Specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Collector to Emitter Breakdown Voltage	BV _{CER}	$I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V},$ $R_{GE} = 1 \text{ K}\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		370	400	430	V
Collector to Emitter Breakdown Voltage	BV _{CES}	$I_{CE} = 10$ mA, $V_{GE} = 0$ V, $R_{GE} = 0$, $T_{J} = -40$ to 150°C		390	420	450	V
Emitter to Collector Breakdown Voltage	BV _{ECS}	I_{CE} = -75 mA, V_{GE} = 0 V, T _J = 25°C		30	-	-	V
Gate to Emitter Breakdown Voltage	BV _{GES}	$I_{GES} = \pm 2 \text{ mA}$		±12	±14	-	V
Collector to Emitter Leakage Current	$B_{QE} = 1 K\Omega$	$T_J = 25^{\circ}C$	-	-	25	μA	
		$T_J = 150^{\circ}C$	-	_	1	mA	
Emitter to Collector Leakage Current	I _{ECS}	V _{EC} = 24 V	$T_J = 25^{\circ}C$	-	-	1	mA
			$T_J = 150^{\circ}C$	-	-	40	
Series Gate Resistance	R ₁	•		-	70	-	Ω
Gate to Emitter Resistance	R ₂			10 K	-	26 K	Ω
ON CHARACTERISTICS		-		-			
Collector to Emitter Saturation Voltage	V _{CE(SAT)}	I _{CE} = 6 A, V _{GE} = 4 V T _J = 25°C		_	1.25	1.65	V
Collector to Emitter Saturation Voltage	V _{CE(SAT)}	$I_{CE} = 10 \text{ A}, V_{GE} = 4.5 \text{ V}$ $T_{J} = 150^{\circ}\text{C}$		-	1.58	1.80	V
Collector to Emitter Saturation Voltage	V _{CE(SAT)}	$I_{CE} = 15 \text{ A}, V_{GE} = 4.5 \text{ V}$ $T_{J} = 150^{\circ}\text{C}$		-	1.90	2.20	V
DYNAMIC CHARACTERISTICS							
Gate Charge	Q _{G(ON)}	I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V		-	17	-	nC
Gate to Emitter Threshold Voltage	V _{GE(TH)}	I_{CE} = 1 mA, V_{CE} = V_{GE}	$T_J = 25^{\circ}C$	1.3	-	2.2	V
			T _J = 150°C	0.75	-	1.8	
Gate to Emitter Plateau Voltage	V _{GEP}	V _{CE} = 12 V, I _{CE} = 10 A		_	3.0	_	V
SWITCHING CHARACTERISTICS		-		-			
Current Turn-On Delay Time-Resistive	td _{(ON)R}	$ \begin{array}{l} V_{CE} = 14 \; V, R_{L} = 1 \; \Omega \\ V_{GE} = 5 \; V, R_{G} = 470 \; \Omega \\ T_{J} = 25^\circ C \end{array} $		-	0.7	4	μS
Current Rise Time-Resistive	t _{rR}			-	2.1	7	
Current Turn-Off Delay Time-Inductive	td _{(OFF)L}			-	4.8	15	
Current Fall Time-Inductive	tfL			-	2.8	15	

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device Marking Device Package		Reel Diameter	Tape Width	Qty	
ISL9V3040G1	ISL9V3040D3STV	DPAK (Pb-Free)	330 mm	16 mm	2500	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

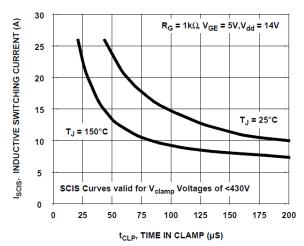


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

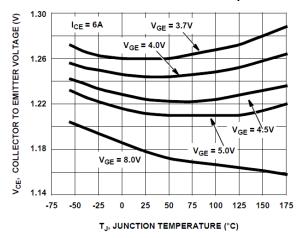


Figure 3. Collector to Emitter On–State Voltage vs. Junction Temperature

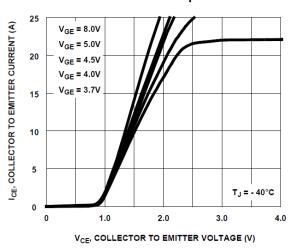


Figure 5. Collector to Emitter On–State Voltage vs. Collector Current

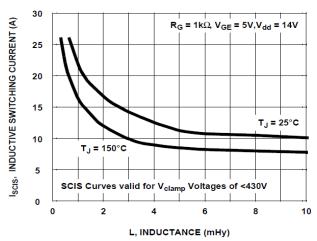


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

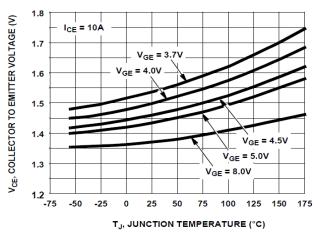


Figure 4. Collector to Emitter On–State Voltage vs. Junction Temperature

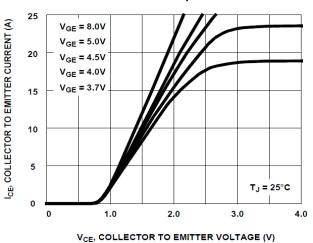
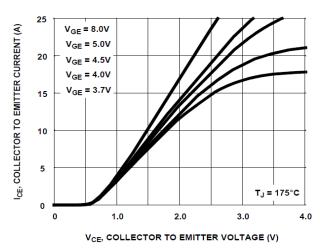
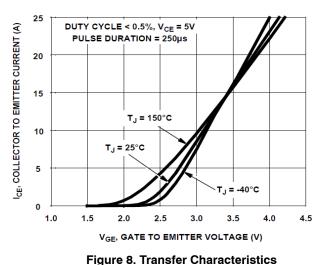


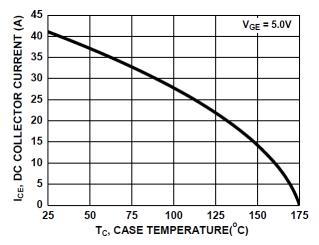
Figure 6. Collector to Emitter On– State Voltage vs. Collector Current

TYPICAL CHARACTERISTICS (continued)

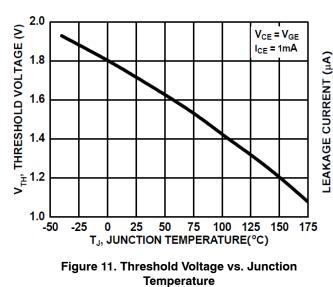






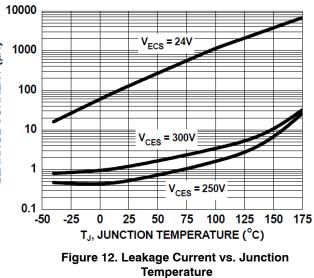




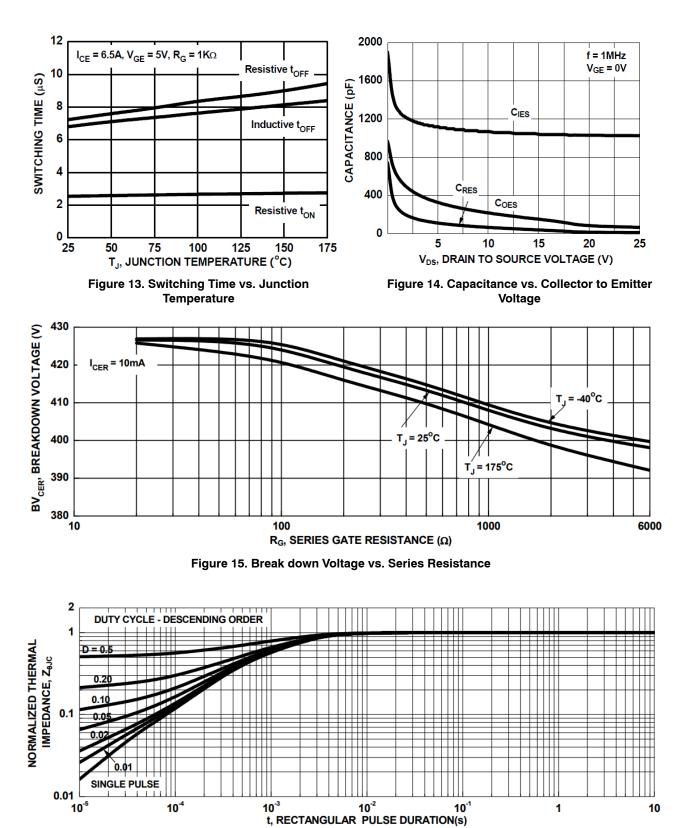


V_{GS}, GATE TO EMITTER VOLTAGE(V) $I_{CE} = 10A, T_{J} = 25^{\circ}C$ V_{CE} = 6V V_{CE} = 12V Q_g, GATE CHARGE(nC)

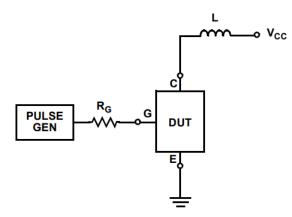
Figure 10. Gate Charge



TYPICAL CHARACTERISTICS (continued)







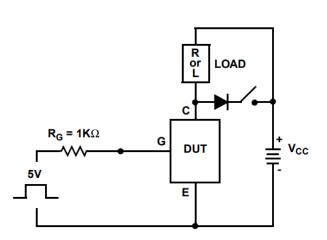


Figure 17. Inductive Switching Test Circuit

Figure 18. t_{ON} and t_{OFF} Switching Test Circuit

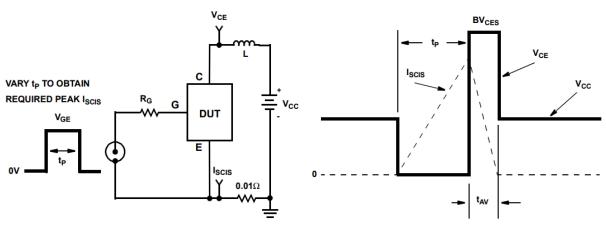
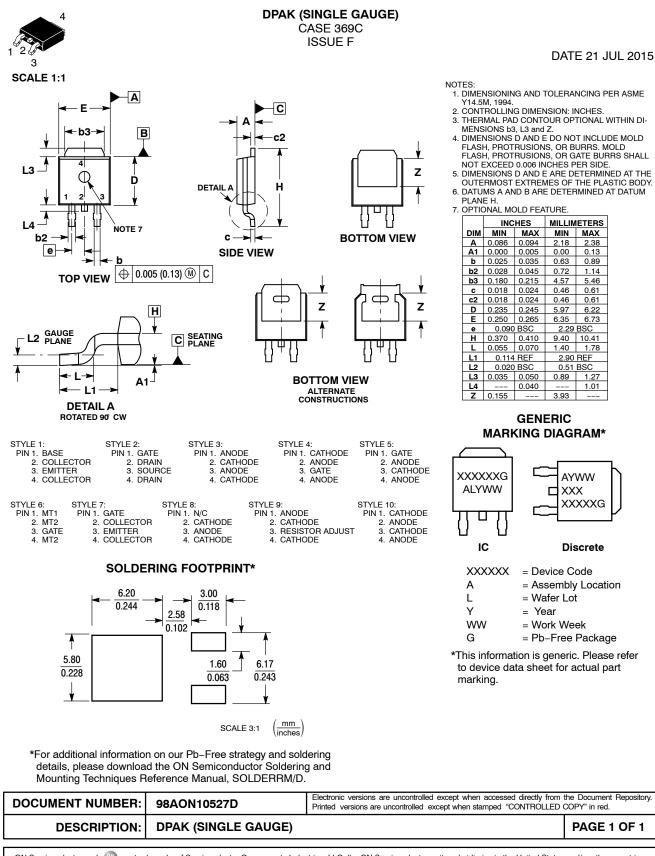


Figure 19. Energy Test Circuit







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